

## Standard Product Specifications



## Features

Package	PLCC-2 Type, Water clean resin Outer Dimension 3.5 x 2.8 x 1.9mm( L x W x H )
Product features	<ul> <li>Wide range temperature applicable product</li> <li>High reliability</li> <li>(for automotive applications and other high-reliability required applications)</li> <li>Lead-free soldering compatible</li> <li>RoHS compliant</li> </ul>

## **Recommended Applications**

•Automotive interior: Switch and buttons , meter panel, car audio , HVAC, etc.



## **Outline Dimensions**



# Recommended Pad



Unit : mm Tolerance : ±0.2



## Specifications

### [ Product Overview ]

Die Material	AlGaInP
Emitting Color	Yellow
Resin Color (Emitting Area)	Water Clear
Resin Color (Lamp Housing)	White

### 【 Absolute Maximum Ratings 】

【 Absolute Maximum Ratings 】		(Ta=	25 )	_
ITEM	symbol	MAXIMUM RATINGS	UNITS	
Power Dissipation	P <sub>d</sub>	217	mW	
Forward Current	I <sub>F</sub>	70	mA	]
Repetitive Peak Forward Current "10ms,1/20duty"	I <sub>FRM</sub>	100	mA	
I <sub>F</sub> Derate Linearly from "75° <b>C</b> "	$\Delta I_{F}$	1.56	mA/° <b>C</b>	
I <sub>FRM</sub> Derate Linearly from "75° <b>C</b> "	$\Delta I_{FRM}$	2.22	mA/° <b>C</b>	
Allowable Reverse Voltage	Vr	5	mA	
Operating Temperature	T <sub>opr</sub>	-40 ~ +100	°C	
Storage Temperature	T <sub>stg</sub>	-40 ~ +120	°C	
Electrostatic Discharge Threshold "HBM"	ESD	1,000	V	Notes1
Soldering Temperature "Reflow Soldering"	T <sub>sld</sub>	260	°C	Notes2

Notes1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF Notes2 Please refer to page 8, Soldering Conditions.

### 【 Thermal Characteristics 】

Inerma	al Characteristics				(Ta=25	
	ITEM	SYMBOL	TYP.	MAX.	UNITS	
	Thermal Resistance 【Junction - Ambient】	$R_{th(j-a)}$	200	-	°C/W	Notes3
	Thermal Resistance 【Junction - Solder point】	$R_{th(j\text{-}s)}$	100	-	°C/W	
	Junction Temperature	Tj	-	120	°C	

Notes3 Rth(j-a) Measurement Condition Substrate:FR-4 (t=1.6mm) Pattern Size : 16mm<sup>2</sup>

## **Specifications**

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ITEM	Symbol	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 50mA	1.8	2.2	2.8	V	
Reverse Current	IR	$V_R = 5V$	-	-	5	μA	
Luminous Intensity	$I_V$	I <sub>F</sub> = 50mA	1,500	2,000	2,700	mcd	Notes4
Luminous Flux	$\Phi_{V}$	I <sub>F</sub> = 50mA	-	5.8	-	lm	
Peak Wavelength	λp	I <sub>F</sub> = 50mA	-	594	-	nm	
Dominant Wavelength	λd	I <sub>F</sub> = 50mA	589	592	595	nm	Notes5
Spectral line Half Width	Δλ	I <sub>F</sub> = 50mA	-	20	-	nm	
Laft Intensity Angle	Δθχ		-	120	-	deg	Notes6
Half Intensity Angle	Δθγ	I <sub>F</sub> = 50mA	-	120	-	deg.	1101630

### [ Electro-Optical Characteristics ]

(Ta=25 )

Above Luminous Intensity(Iv) values and Dominant Wavelength ( $\lambda d$ ) values are the setup value of the selection machine.

[Tolerance :  $Iv = \pm 10\%$ ,  $\lambda d = \pm 1 nm$ ]

Notes 4,5 Please refer to the attached sheets, each sorting chart.

Notes 6 Viewing Angle at 50% Iv,  $\Delta\theta x$ : Housing long side axis,  $\Delta\theta y$ : Housing short side axis

### [Sorting Chart for Luminous Intensity and Dominant Wavelength]

LEDs shall be sorted out into the following chart and each rank parts shall be packed separately when shipping.

Rank	Luminous Intensity Iv(mcd)		Conditions
	MIN.	MAX.	
D3	1,500	1,800	
D4	1,800	2,200	Ta=25° <b>C</b> , I <sub>F</sub> =50mA
D5	2,200	2,700	

Rank	Dominant Wavelength λ d(nm)		Conditions
	MIN.	MAX.	
E	589	592	Ta=25 <b>℃</b> ,
F	592	595	I <sub>F</sub> =50mA

Above Luminous Intensity(Iv) values and Dominant Wavelength ( $\lambda d$ ) values are the setup value of the selection machine.

[Tolerance :  $Iv = \pm 10\%$ ,  $\lambda d = \pm 1 nm$ ]

## **Technical Data**







## Technical Data





## Soldering condition



#### [Soldering Precaution]

(acc.to EIAJ-4701/300)

- 1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
- 2. LED parts including the resin are not stable immediately after soldering ( when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
- 3. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density.

Please do not repeat the heating process in Reflow process more than twice.



Note 1 Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.



- 4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touch the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
- 5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any type of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

#### [Recommended Manual Soldering Condition]

Temperature of Iron Tip	350 MAX.
Soldering Duration, Time	3sec.Max.,1 time

- 7. Flow soldering (dip soldering) is not recommended for this product.
- 8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

Chemical	Adaptability
Isopropyl Alcohol	0
Trichloroethylene	×
Chlorothene	×
Acetone	×
Thinner	×

## Handling Precaution



### [Other Precautions]

- 1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions
- 2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress( temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
- 3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. ( Derating of TYP., MAX Forward Voltage, etc.)
- 4. Please insert Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
- 5. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. Also please don't touch lens portion.
- 6. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
- 7. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
- 8. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
- 9. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health ( such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
- 10. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
- 11. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

## Handling Precaution



[Handling Precautions for Product Mounting] <Recommendation>

1. Picking up point with nozzle: Lamp housing of the product ( ZZZ area) (Shown below)

The picking up point should be within lamp housing portion, because the silicone resin used for the lens is soft. (If the nozzle makes contact with the lens, the products might be destroyed)



Please adjust the load, the pick up point, the nozzle diameter, etc. before mounting because the over load can cause the breakage of the lamp housing.

2. Recommended Nozzle shape



Nozzle with chamfering is recommended



This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

[Recommended Storage Condition / Products Warranty Period]

Temperature	+5~30
Humidity	Under 70%

In the case of the package unopened , 6 months under [ Recommended Storage Condition ]. Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

#### [Time elapsed after Package Opening]

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering as is [maximum 4weeks(672h)]. If the device needs to be soldered twice, both soldering operations must be completed within the 4weeks(672h).

If any components should remain unused, please reseal the package and store them under the conditions described in the [ Recommended Storage Condition ] above.

This product must be required to perform baking process (moisture removal) for at 48h( MIN.).~72h(MAX.) at  $60 \pm 5$  degrees Celsius if following conditions apply.

1.In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.

2. In the case of time passes for 4weeks(672h) after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.





#### [Flow Chart-package Opening to Mounting]



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

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## [Packing box]

( RoHS•ELV Compliant)

Вох Туре	Outline dimension L × W × H (mm)	Capacity of the box
Туре А	280 × 265 × 45 (mm)	3 reels
Туре В	310 × 235 × 265 (mm)	15 reels
Туре С	440 × 310 × 265 (mm)	30 reels

The above measures are all the reference values.

The box is selected out of the above table by shipping quantity.



Type A Material / box : Cardboard C5BF Type B,C Material / box : Cardboard K5AF Partition : Cardboard K5AF



## Packaging Specifications

### 【Label Specification】 ( acc.to JIS-X0503(Code-39)

A) Product label

 STANLEY
 -STANLEY
 ELECTRIC
 CO., LTD. 

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- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank
- (refer to Lot Number Notational System for details )
- G. Bar-Code for Lot number & Rank



- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

<Remarks> Bar-code font : acc.to Code-39(JIX0503)



(acc.to JIS-C0806-03)

[Appearance]



#### Note

"-TR" means cathode side of LEDs should be placed on the sprocket-hole side.

lte	ms	Specifications	Remarks	
Looden ener	Cover-tape	Cover-tape shall be longer than 320mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.	
Leader area	Carrier-tape	Empty pocket shall be more than 20 pieces.	Please refer to the above figure for Taping & reel orientation .	
Traile	r area	Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.	



#### (acc.to JIS-C0806-03)

### [Qty. per Reel]

#### 2,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 2,000 parts. In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

#### [Mechanical strength]

Cover-tape adhesive strength shall be  $0.1 \sim 1.0$ N (An angle between carrier-tape and cover-tape shall be 170 deg.) Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

### [Others]

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mixing shall not be held. Max. qty. of empty pocket per reel shall be defined as follows.

Qty./reel	Max. qty. of empty pocket	Remark	
500	1	-	
1,000	1	-	
1,500	1	-	
2,000	2	No continuance	



Unit : mm

#### (acc.to JIS-C0806-03) 【Taping Dimensions】





- ① 1 digit : Production Location (Mark identify alphabet)
- ② 1 digit : Production Year (Last digit of Production Year 2009 9,2010 0,2011 1,...)
- ③ 2digits : Production Month (Jan. to Sep. , should be 01,02,03,....)
- (4) 2digits : Production Date
- ⑤ 3digits : Serial Number
- (6) 2digits : Tape and Reel following Number
- ⑦ 2digits : Luminous Intensity Rank.
   (If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.
   If there is no identified intensity rank, "--" is used to indicate.)

#### (8) - 2digits : Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit. If there is no identified intensity rank, "--" is used to indicate.)

(9) - 1 digit : Option Rank (Stanley normally print "-" to indicate)



This product is in compliance with RoHS•ELV.

Prohibition substance and it's criteria value of RoHS•ELV are as follows.

•RoHS instruction ..... Refer to following  $(1)\sim(6)$ .

•ELV instruction ...... Refer to following (1) $\sim$ (4).

	Substance Group Name	Criteria Value	
(1)	Lead and its compounds	1,000ppm Max	
(2)	Cadmium and its compounds	100ppm Max	
(3)	Mercury and its compounds	1,000ppm Max	
(4)	Hexavalent chromium	1,000ppm Max	
(5)	PBB	1,000ppm Max	
(6)	PBDE	1,000ppm Max	



## 1. Reliability Testing Result

Test Item	Refrerence Standard	Test Condition		Failure
Room Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=25 I <sub>F</sub> =70mA	1 <i>,</i> 000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85 I <sub>F</sub> =50mA	1 <i>,</i> 000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701/100(101)	Ta=-40  I <sub>F</sub> =70mA	1 <i>,</i> 000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701/100(102)	Ta=60 90% I <sub>F</sub> =70mA	1 <i>,</i> 000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701/200(201)	Ta=120	1 <i>,</i> 000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701/200(202)	Ta=-40	1,000h	0 / 20
Wet High Temperature Storage Life	EIAJ ED-4701/100(101)	Ta=60 Rh=90%	1 <i>,</i> 000h	0 / 20
Thermal Shock	EIAJ ED-4701/100(105)	Ta=-40 ~120 (each 15min)	1,000cycles	0 / 20
Thermal Shock Operating	EIAJ ED-4701/100(105)	Ta≕40 (OFF) <b>~</b> 85 (I <sub>F</sub> =50mA ON) (each 15min)	1,000cycles	0 / 20
Cycled Temperature Humidity Operating Life	EIAJ ED-4701/200(203)	Ta≕30 <b>~</b> 80 95(2h) 8h/cycle I <sub>F</sub> =57mA 5min on-off	30 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701/300(301)	Moisture Soak : 30 70% 4weeks(672h) / Preheating : 150~180 90-120sec MAX. / Soldering : 260 peak	2times	0 / 20
Electrostatic Discharge (ESD)	EIAJ ED-4701/300(304)	C=100pF R2=1.5k $\Omega \pm ,2000V$ once ea polarity		0 / 10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s2(10G) 100~2,000Hz 20min XYZ Each direction		0 / 10

**Reference Test** 

### 2. Failure Criteria

ltem	Symbol	Condition	Failure Criteria
Luminous Intensity	$I_V$	I <sub>F</sub> =50mA	Testing Min. Value < Standard Min. Value $\times$ 0.5
Forward Voltage	$V_{F}$	I <sub>F</sub> =50mA	Testing Max. Value Standard Max. Value × 1.2
Reserve Current	I <sub>R</sub>	V <sub>R</sub> =5V	Testing Max. Value Standard Max. Value × 2.5
Cosmetic Appearance	-	-	Notable discoloration, deformation and cracking



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